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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Bruno GHYSELEN et al.

Confirmation No.: 8095

Application No.: 10/615,259

Group Art Unit: 2818

Filing Date: July 9, 2003

Examiner: Thao P. Le

For: PROCESS FOR TRANSFERRING A LAYER
OF STRAINED SEMICONDUCTOR
MATERIAL

Attorney Docket No.: 4717-7500

SUBMISSION OF REPLACEMENT FORMAL DRAWINGS

Mail Stop Issue Fee

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Submitted herewith are nine (9) sheets of formal drawings including Figs. 1a-1d, 2a-2d, 3a-3e, 4a-4e, 5a-5g and 6a-6c. Applicants respectfully request that the attached drawings be substituted for the drawings originally filed in this application. These drawings have merely been formalized rather than corrected, and no new matter is believed to have been added.

No fee is believed to be due for this submission. Should any fees be required, however, please charge such fees to Winston & Strawn LLP Deposit Account No. 50-1814.

Respectfully submitted,

July 22, 2005

Date

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WINSTON & STRAWN LLP

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